

DESCRIPTION

The MP1921B is a high-frequency 100V halfbridge N-channel power MOSFET driver. Its lowside and high-side driver channels are independently controlled and matched, with a time delay of less than 5ns. Under-voltage lockout on both high-side and low-side supplies force their outputs low in case of insufficient supply. The integrated bootstrap diode reduces external component count.

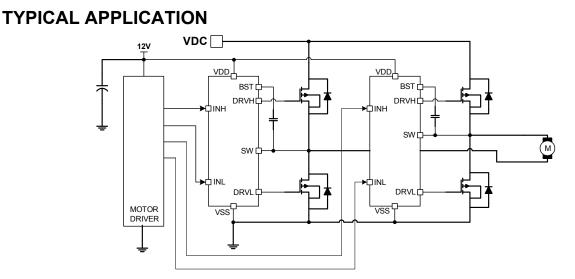
FEATURES

- Drives N-Channel MOSFET Half-Bridge
- 120V V_{BST} Voltage Range
- On-Chip Bootstrap Diode
- Typical 16ns Propagation Delay Time
- Less Than 5ns Gate Drive Matching
- Drives 1nf Load with 12ns/9ns Rise/Fall Times with 12V VDD
- TTL Compatible Input
- Less Than 150µA Quiescent Current
- UVLO for Both High Side and Low Side
- In QFN10 (3mmx3mm) Package

APPLICATIONS

- Telecom Half-Bridge Power Supplies
- Avionics DC/DC Converters
- Two-Switch Forward Converters
- Active-Clamp Forward Converters
- DC Motor Drivers

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ORDERING INFORMATION

Part Number*	Package	Top Marking			
MP1921GQ-B	QFN10 (3mmx3mm)	See Below			

* For Tape & Reel, add suffix –Z (e.g. MP1921GQ-B–Z).

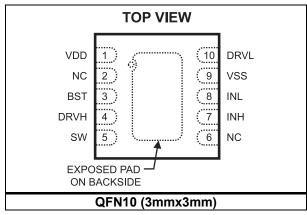
TOP MARKING

BLDY

LLL

BLD: Product code of MP1921GQ-B Y: Year code LLL: Lot number

PACKAGE REFERENCE





MP1921B - 100V, 2.5A, HIGH-FREQUENCY HALF-BRIDGE GATE DRIVER

PIN FUNCTIONS

QFN10 (3x3mm)	Name	Description
1	VDD	Supply input. VDD supplies power to all the internal circuitry. A decoupling capacitor to ground must be placed close to VDD to ensure stable and clean supply.
2,6	NC	No connection.
3	BST	Bootstrap. This is the positive power supply for the internal floating high-side MOSFET driver. Connect a bypass capacitor between BST and SW.
4	DRVH	Floating driver output.
5	SW	Switching node.
7	INH	Control signal input for the floating driver.
8	INL	Control signal input for the low-side driver.
9	VSS, Exposed Pad	Chip ground. Connect exposed pad to VSS for proper thermal operation.
10	DRVL	Low-side driver output.



ABSOLUTE MAXIMUM RATINGS (1)

Supply voltage (V _{DD}) SW voltage (V _{SW}) BST voltage (V _{BST}) BST to SW	5.0V to +105V 0.3V to +120V
DRVH to SW	
	(BST-SW) + 0.3V
DRVL to VSS	0.3V to (VDD + 0.3V)
All other pins	0.3V to (V _{DD} + 0.3V)
Continuous power dissipa	ation (T _A =25°C) ⁽²⁾
QFN10 (3mmx3mm)	
Junction temperature	150°C
Lead temperature	
Storage temperature	65°C to +150°C

Recommended Operating Conditions ⁽³⁾

Supply voltage (V _{DD})		. 9.0V to 18V
SW voltage (V _{SW})	1.	0V to +100V
SW slew rate		<50V/ns
Operating junction temp (T_J) .	40°	°C to +125°C
Thermal Resistance ⁽⁴⁾	θ _{JA}	$\boldsymbol{\theta}_{JC}$
QFN10 (3mmx3mm)	50	12°C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J(MAX), the junction-to-ambient thermal resistance θ_{JA}, and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D(MAX) = (T_J(MAX) T_A) / θ_{JA}. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS

V_{DD} = V_{BST} - V_{SW} = 12V, V_{SS} = V_{SW} = 0V, no load at DRVH and DRVL, T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Supply Currents						
VDD quiescent current	IDDQ	INL = INH = 0		100	150	μA
VDD operating current	Iddo	f _{sw} = 500kHz		2.8	3.5	mA
Floating driver quiescent current	IBSTQ	INL = INH = 0		60	90	μA
Floating driver operating current	I _{BSTO}	f _{sw} = 500kHz		2.1	3	mA
Leakage current	Ilk	BST = SW = 100V		0.05	1	μA
Inputs		•			•	
INL/INH high				2	2.4	V
INL/INH low			1	1.4		V
INL/INH internal pull-down resistance	RIN			185		kΩ
Under-Voltage Protection			•			
VDD rising threshold	Vddr		7.7	8.1	8.5	V
VDD hysteresis	Vddh			0.5		V
(BST-SW) rising threshold	VBSTR		6.7	7.1	7.5	V
(BST-SW) hysteresis	VBSTH			0.55		V
Bootstrap Diode		•			•	•
Bootstrap diode VF @ 100µA	V _{F1}			0.5		V
Bootstrap diode VF @ 100mA	V _{F2}			0.9		V
Bootstrap diode dynamic R	RD	@ 100mA		2.5		Ω
Low-Side Gate Driver						
Low-level output voltage	Voll	Io = 100mA		0.15	0.22	V
High-level output voltage to rail	VOHL	I ₀ = -100mA		0.45	0.6	V
	IOHL	$V_{DRVL} = 0V, V_{DD} = 12V$		1.5		Α
Peak pull-up current		$V_{DRVL} = 0V, V_{DD} = 16V$		2.5		Α
De els avallades en accest	Ioll	$V_{DRVL} = V_{DD} = 12V$		2.5		Α
Peak pull-down current		$V_{DRVL} = V_{DD} = 16V$		3.5		Α
Floating Gate Driver		•			•	•
Low-level output voltage	V _{OLH}	I _O = 100mA		0.15	0.22	V
High-level output voltage to rail	Vohh	I _O = -100mA		0.45	0.6	V
	Іонн	$V_{DRVH} = 0V, V_{DD} = 12V$		1.5	I	Α
Peak pull-up current		$V_{DRVH} = 0V, V_{DD} = 16V$		2.5		Α
		$V_{DRVH} = V_{DD} = 12V$		2.5	Ī	Α
Peak pull-down current	Iolh	$V_{DRVH} = V_{DD} = 16V$		3.5		Α



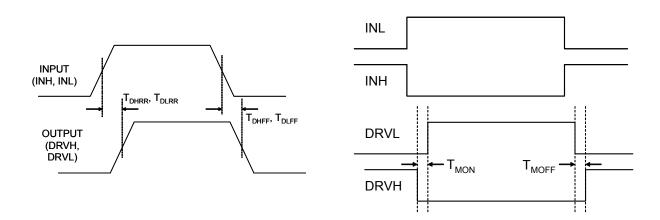
ELECTRICAL CHARACTERISTICS (continued)

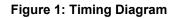
 V_{DD} = V_{BST} - V_{SW} = 12V, V_{SS} = V_{SW} = 0V, no load at DRVH and DRVL, T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Switching Spec. – Low Side Gat	e Driver					
Turn-off propagation delay INL falling to DRVL falling	TDLFF			16		ns
Turn-on propagation delay INL rising to DRVL rising	T _{DLRR}			16		
DRVL rise time		C∟= 1nF		12		ns
DRVL fall time		C∟= 1nF		9		ns
Switching Spec. – Floating Gate	Driver					
Turn-off propagation delay INL falling to DRVH falling	TDHFF			16		ns
Turn-on propagation delay INL rising to DRVH rising	T _{DHRR}			16		ns
DRVH rise time		C∟= 1nF		12		ns
DRVH fall time		C _L = 1nF		9		ns
Switching Spec. – Matching						
Floating driver turn-off to low side drive turn-on	T _{MON}			1	5	ns
Low side driver turn-off to floating driver turn-on	T_{MOFF}			1	5	ns
Minimum input pulse width that changes the output	T _{PW}				50 ⁽⁵⁾	ns
Bootstrap diode turn-on or turn- off time	T _{BS}			10 (5)		ns

Note:

5) Guaranteed by design.

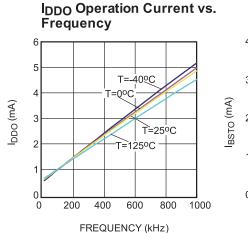


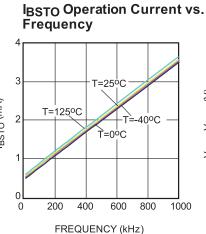


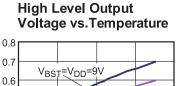


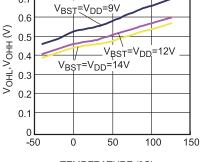
TYPICAL PERFORMANCE CHARACTERISTICS

 V_{DD} = 12V, V_{SS} = V_{SW} = 0V, T_A = 25°C, unless otherwise noted.



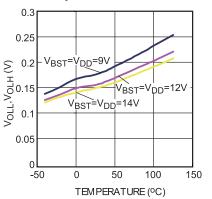




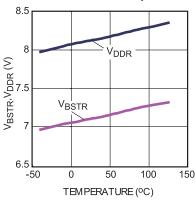


TEMPERATURE (°C)

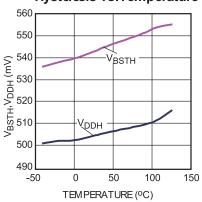
Low Level Output Voltage vs. Temperature

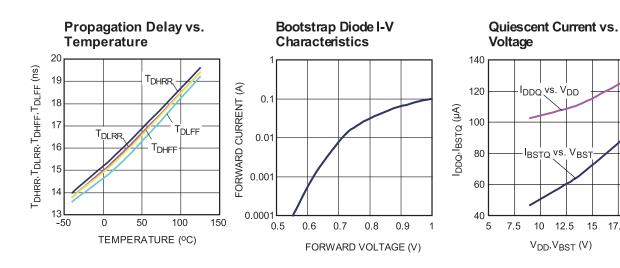


Undervoltage Lockout Threshold vs. Temperature









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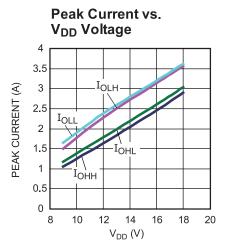
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15



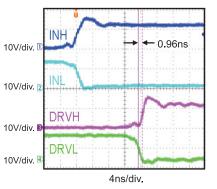
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{DD} = 12V, V_{SS} = V_{SW} = 0V, T_A = 25°C, unless otherwise noted.

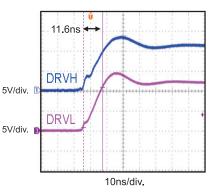


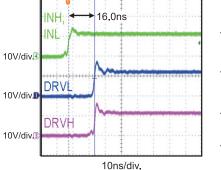
Turn-On Propagation Delay

Gate Drive Matching T_{MOFF}



Drive Rise Time (1nF Load)

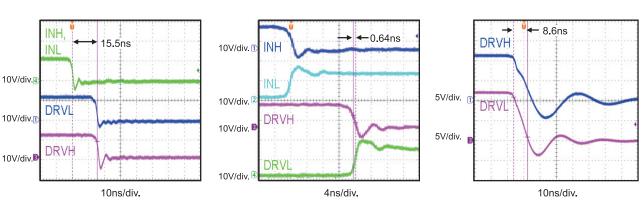






Gate Drive Matching T_{MON}

Drive Fall Time (1nF Load)



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BLOCK DIAGRAM

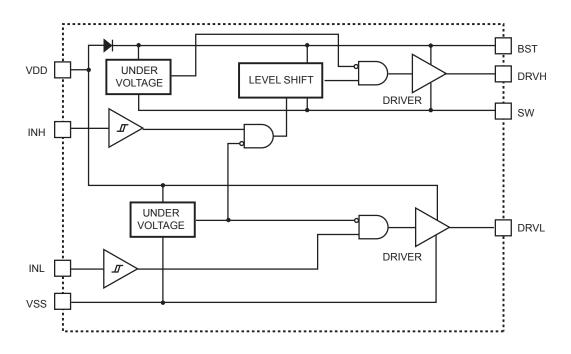


Figure 2: Function Block Diagram



APPLICATION

The INH and INL input signals can be controlled independently. If both INH and INL are controlling the HS-FET and LS-FET of the same bridge, then users must avoid shoot-through by setting

a sufficient dead time between INH and INL low, and vice versa (see Figure 3). Dead time is the time interval between INH low and INL low.

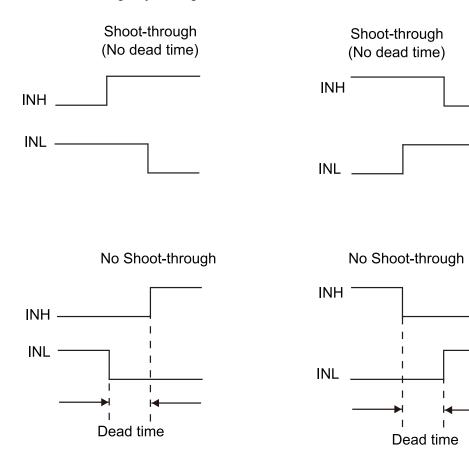


Figure 3: Short-Through Timing Diagram



REFERENCE DESIGN CIRCUITS

Half-Bridge Converter

In half-bridge converter topology, the MOSFETs are driven alternately with dead time. Therefore, INH and INL are driven with alternating signals

from the PWM controller (see Figure 4). Input voltage can be up to 100V in this application.

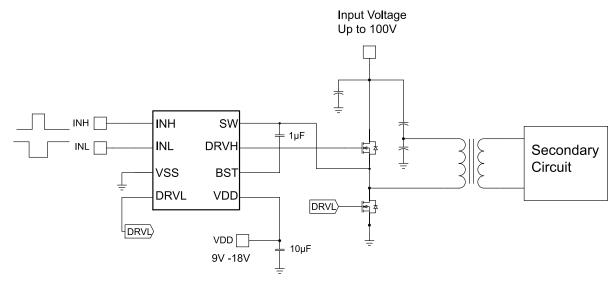


Figure 4: Half-Bridge Converter

Two-Switch Forward Converter

In two-switch forward converter topology, both MOSFETs are turned on and off together. The input signal (INH and INL) comes from the PWM controller, which senses the output voltage and output current if current-mode control is used (see

Figure 5). The Schottky diodes clamp the reverse swing of the power transformer, and must be rated at the input voltage. Input voltage can be up to 100V in this circuit.

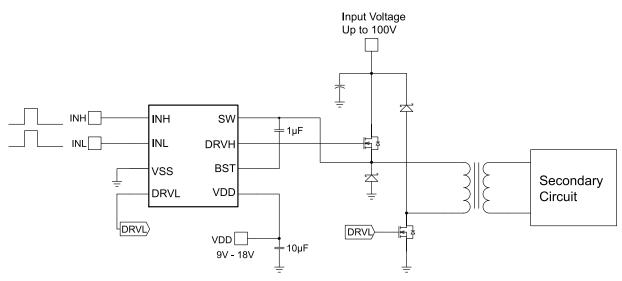


Figure 5: Two-Switch Forward Converter



Active-Clamp Forward Converter

In active-clamp forward converter topology, the MOSFETs are driven alternately. The high-side MOSFET, along with capacitor C_{reset} , is used to reset the power transformer in a lossless manner.

This topology lends itself well to run at duty cycles exceeding 50%. For these reasons, the input voltage may not be able to run at 100V for this application.

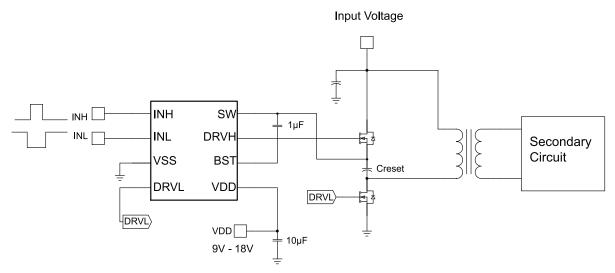
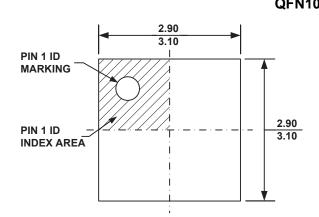
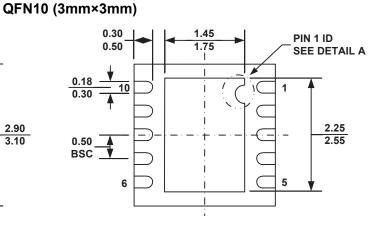


Figure 6: Active-Clamp Forward Converter



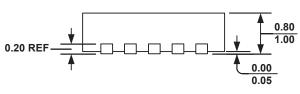
PACKAGE INFORMATION



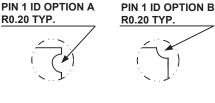


TOP VIEW

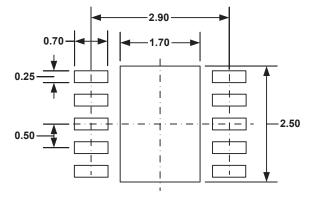
BOTTOM VIEW



SIDE VIEW



DETAIL A



<u>NOTE:</u>

1) ALL DIMENSIONS ARE IN MILLIMETERS.

2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.

3) LEAD COPLANARITY SHALL BE 0.10 MILLIMETER MAX.

4) DRAWING CONFORMS TO JEDEC MO-229, VARIATION VEED-5.

5) DRAWING IS NOT TO SCALE.

RECOMMENDED LAND PATTERN

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